

Power Zener Diodes

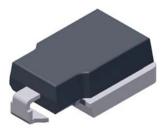
Features and Benefits

- \bullet DC blocking voltage, $V_{DC},\,22$ to 32 V
- Low V_F (0.95 to 1.0 V max, at $I_F = 6$ A)
- Low reverse leakage current, $I_R = 10 \mu A$
- High temperature range
- Flammability: UL94V-0 (Equivalent)

Applications

- High peak power
- High-temperature
- Clamping diode
- General use Zener diode

Package: Surface Mount SZ-10

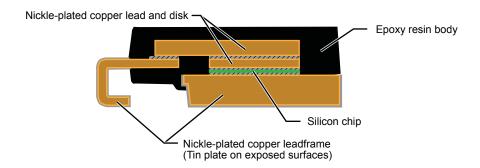


Not to scale

Description

The SZ-10 series are 22 V and 32 V Zener diodes capable of withstanding high peak power surges. The resin case and substantial mounting surfaces allow substantial heat dissipation, and operating temperatures up to $T_J = 175$ °C, facilitating heat-dissipation design.

Product Structure



Selection Guide

Part Number	Permissible Power Dissipation, P _D (W)	DC Blocking Voltage, V _{DC} (V)	Peak Surge Reverse Current, I _{RSM} (A)	Forward Voltage, V _F (max) (V)	Breakdown Voltage, V _Z (V)	Breakdown Region Equivalent Resistance, R _Z (typ) (V)	Tape and Reel Packing
SZ-10N27VL	5	22	70	1.0	24 to 30	0.08	Cathode Left
SZ-10N40VL	5	32	45	1.0	36 to 44	0.2	Cathode Left
SZ-10NN27VL	6	22	90	0.98	24 to 30	0.08	Cathode Left
SZ-10NN40VL	6	32	70	0.95	36 to 44	0.1	Cathode Left

Absolute Maximum Ratings

Characteristic	Symbol	Conditions		Rating	Unit
Dermissible Dewer Dissipation	P _D	SZ-10N27 SZ-10N40	See Power Derating chart	5	W
Permissible Power Dissipation		SZ-10NN27 SZ-10NN40	See Power Derating chart	6	W
DC Blocking Voltage	V _{DC}	SZ-10N27 SZ-10NN27		22	V
DC Blocking Voltage		SZ-10N40 SZ-10NN40		32	V
	I _{RSM}	SZ-10N27 SZ-10NN40	Refer to figure 1	70	А
Peak Surge Reverse Current		SZ-10N40		45	Α
		SZ-10NN27		90	Α
Junction Temperature	TJ			-55 to 175	°C
Storage Temperature	T _{stg}			-55 to 175	°C

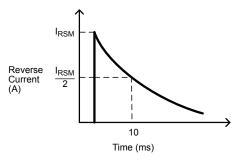
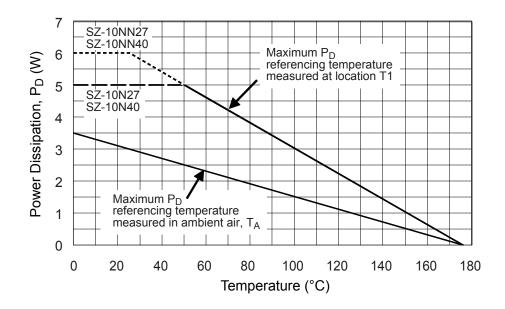


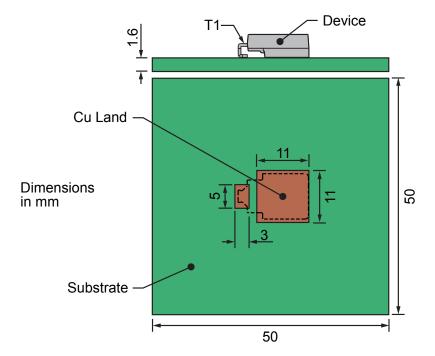
Figure 1. Waveform of reverse current surge

Electrical Characteristics valid at $T_A = 25$ °C, unless otherwise specified

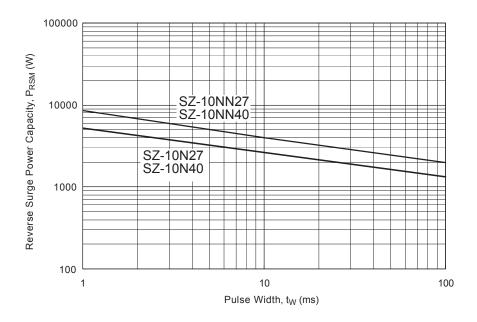
Characteristic	Symbol	Test Conditions		Value	Unit
		SZ-10N27 SZ-10N40	N40 NN27 I _F = 6 A	1.0 (max)	V
Forward Voltage Drop	V _F	SZ-10NN27		0.98 (max)	V
		SZ-10NN40		0.95 (max)	V
Reverse Leakage Current	I _R	$V_R = V_{DC}$		10 (max)	μΑ
Progledown Voltago	V	SZ-10N27 SZ-10NN27	I _Z = 10 mA	24 to 30	V
Breakdown Voltage	V _Z	SZ-10N40 SZ-10NN40		36 to 44	V
Breakdown Voltage Temperature Coefficient	r _Z		I _Z = 10 mA	36 (typ)	mV/°C
Breakdown Region Equivalent		SZ-10N27 SZ-10NN27	I _Z = 1 to 10 A	0.8 (typ)	Ω
Resistance	R_z	SZ-10N40		0.2 (typ)	Ω
		SZ-10NN40		0.1 (typ)	Ω

Power Derating





Peak Surge Reverse Power



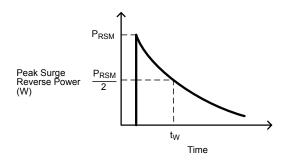
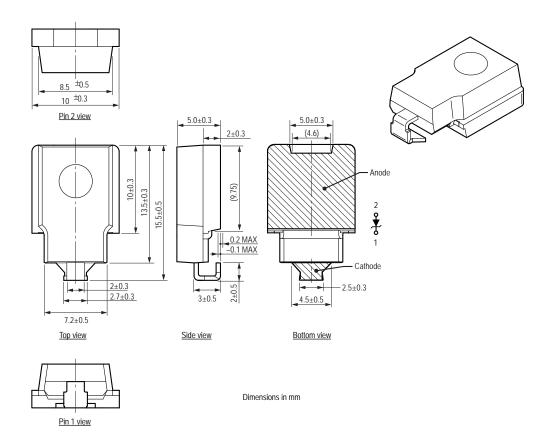
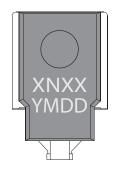


Figure 2. Waveform of reverse power surge

Package Outline



Package Marking



- 1. Product Type Number: xNxx (see table)
- 2. Lot Number:

1st letter: last digit of year 2nd letter: month

1 through 9 – January through September O – October, N – November, D – December

3rd and 4th letters: day of month

(2 digits)

Example: 3507 indicates May 7, 2013

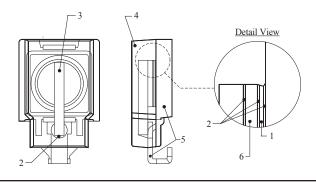
Product Type Number	Abbreviation of		
BN27	SZ-10N27		
BN40	SZ-10N40		
DN27	SZ-10NN27		
DN40	SZ-10NN40		

Material Composition and Internal Structure



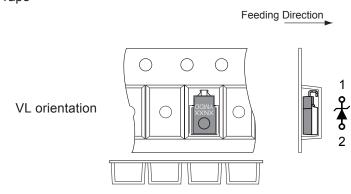
Pin treatment Pb-free. Device composition compliant with the RoHS directive.

- 1. Chip: Si
- 2. Solder: Pb-based
- 3. Inside lead: Ni-plated Cu
- 4. Body: Plastic, epoxy resin
- 5. Leadframe: Ni-plated Cu, external exposed surfaces Sn plated over
- 6. Disk: Ni-plated Cu

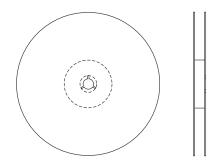


Packing Options

Embossed Tape



Reel



750 pieces per reel

- (1) Device is placed in the embossed pocket with the mounting electrode down.
- (2) 150 to 200 mm leader tape is attached to the tip of the tape.
- (3) 10 or more blank pockets are provided at both the beginning and the end of the tape.

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